

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
30	0.011 at V _{GS} = 10 V	12		
	0.0145 at V _{GS} = 4.5 V	9.8		

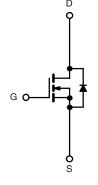
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested



APPLICATIONS

- Notebook PC
 - Core
 - System Power



N-Channel MOSFET

	SO-8	
S 1		8 D
S 2		7 D
S 3		6 D
G 4		5 D
L	Top View	

Ordering Information: Si4688DY-T1-E3 (Lead (Pb)-free)

Si4688DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted							
Parameter		Symbol	10 s	Steady State	Unit		
Drain-Source Voltage		V _{DS}	30		V		
Gate-Source Voltage		V _{GS}	± 20				
Ocaliana Paris Ocara I/T 450 00\8	T _A = 25 °C	- I _D	12	8.9			
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		9.5	7.1			
Pulsed Drain Current		I _{DM}	40		Α		
Continuous Source Current (Diode Conduction) ^a		I _S	2.3	1.3			
Single Pulse Avalanche Current	1 0.1 ml l	I _{AS}	20				
Avalanche Energy	L = 0.1 min	L = 0.1 mH E _{AS}		20			
M	T _A = 25 °C	В	2.5	1.4	147		
Maximum Power Dissipation ^a	T _A = 70 °C	- P _D	1.6	0.9	W		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Manipulation to Applicate	t ≤ 10 s	R _{thJA}	43	50	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		73	90		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	19	25		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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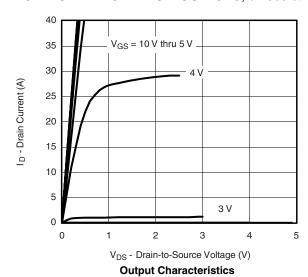
Parameter	Symbol	mbol Test Conditions		Тур.	Max.	Unit	
Static	<u> </u>		<u>'</u>				
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0		3.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	1	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1		
	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ 30			Α	
Drain-Source On-State Resistance ^a	В	V _{GS} = 10 V, I _D = 12 A			0.011	Ω	
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 9.8 \text{ A}$			0.0145		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 12 A		32		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 2.3 A, V _{GS} = 0 V		0.76	1.1	V	
Dynamic ^b			<u>'</u>				
Input Capacitance	C _{iss}			1580		pF	
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		295			
Reverse Transfer Capacitance	C _{rss}			140			
Total Gate Charge	Q_{g}	$V_{DS} = 15 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 12 \text{ A}$		13.2	20	nC	
Total Gate Charge	∢ g			25.4	38		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 12 \text{ A}$		5.3			
Gate-Drain Charge	Q_{gd}			4.3			
Gate Resistance	R_g		0.9	1.8	2.7	Ω	
Turn-On Delay Time	t _{d(on)}			13	20		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 15 \Omega$		10	15		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1 A, V_{GEN} = 10 V, R_g = 6 Ω		33	50	ns	
Fall Time	t _f			10	15		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.3 A, dI/dt = 100 A/μs		25	40		

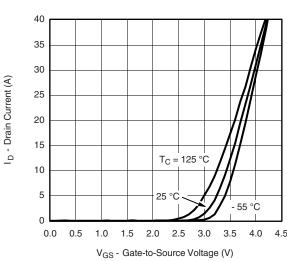
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



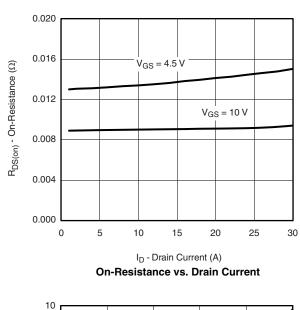


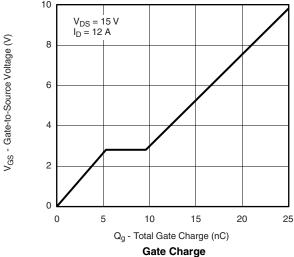






TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





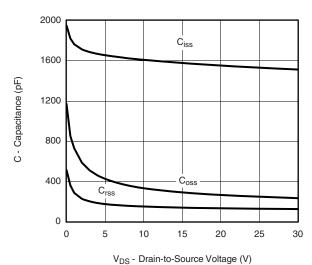
T_J = 150 °C

T_J = 25 °C

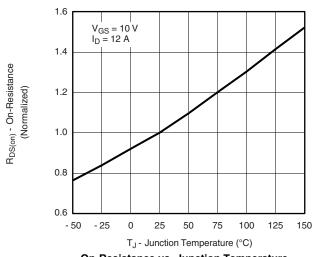
T_J = 25 °C

V_{SD} - Source-to-Drain Voltage (V)

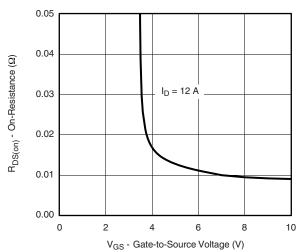
Source-Drain Diode Forward Voltage



Capacitance



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

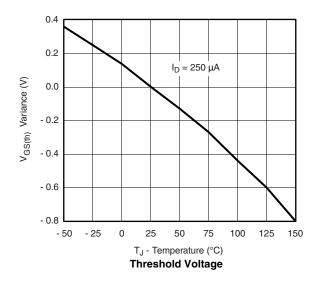
30

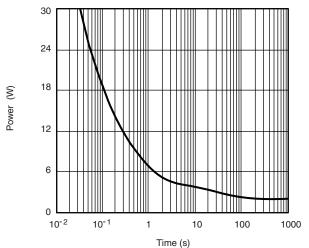
Is - Source Current (A)

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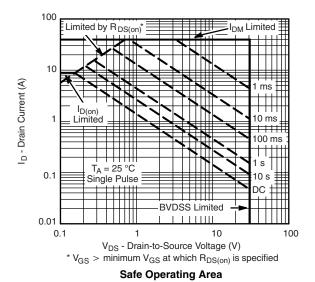
VISHAY

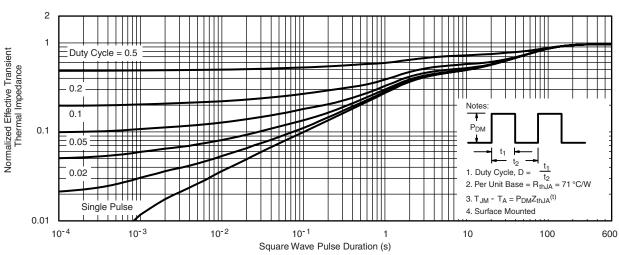
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Single Pulse Power, Junction-to-Ambient

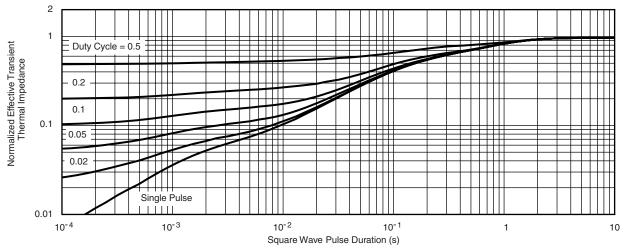




Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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